

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>CHE-WEI HSU</td> <td>06/20/2013</td> </tr> <tr> <td>SHIH-PING HSU</td> <td>06/17/2013</td> </tr> </tbody> </table>		Name	Execution Date	CHE-WEI HSU	06/20/2013	SHIH-PING HSU	06/17/2013
Name	Execution Date						
CHE-WEI HSU	06/20/2013						
SHIH-PING HSU	06/17/2013						
RECEIVING PARTY DATA							
Name:	Zhen Ding Technology Co., Ltd.						
Street Address:	No. 6, Lane 28, San Ho Rd., San Shi Village						
City:	Tayuan, Taoyuan						
State/Country:	TAIWAN						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13925136</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13925136		
Property Type	Number						
Application Number:	13925136						
CORRESPONDENCE DATA							
Fax Number:	7147357469						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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Correspondent Name:	Clifford O. Chi						
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ATTORNEY DOCKET NUMBER:	US45535						
NAME OF SUBMITTER:	Clifford O. Chi						
Signature:	/Clifford O. Chi/						
Date:	06/26/2013						
Total Attachments: 3 source=US45535130620ASM#page1.tif source=US45535130620ASM#page2.tif source=US45535130620ASM#page3.tif							

CH \$40.00 13925136

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. CHE-WEI HSU , residing at Tayuan, Taoyuan, Taiwan
- 2. SHIH-PING HSU , residing at Tayuan, Taoyuan, Taiwan
- 3. _____ , residing at _____
- 4. _____ , residing at _____
- 5. _____ , residing at _____
- 6. _____ , residing at _____
- 7. _____ , residing at _____
- 8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **ZHEN DING TECHNOLOGY CO., LTD.** having a principal place of business at **No. 6, Lane 28, San Ho Rd., San Shi Village, Tayuan, Taoyuan, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **MULTI-LAYER CIRCUIT BOARD AND METHOD FOR MANUFACTURING SAME** for which the undersigned

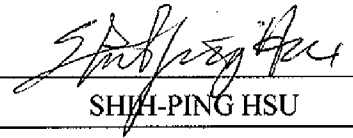
[] previously executed --- Ser. No. _____ and filing date of _____
[X] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>CHE-WEI HSU</u> CHE-WEI HSU	<u>2013.6.20</u> Date
2.	_____	_____ Date
3.	_____	_____ Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date

1.	_____	_____	Date
2.	 SHI-PING HSU	<u>2013/06/17</u>	Date
3.	_____	_____	Date
4.	_____	_____	Date
5.	_____	_____	Date
6.	_____	_____	Date
7.	_____	_____	Date
8.	_____	_____	Date
9.	_____	_____	Date